SDAS212A – DECEMBER 1983 – REVISED DECEMBER 1994

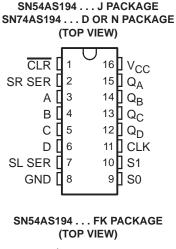
- Parallel-to-Serial, Serial-to-Parallel Conversions
- Left or Right Shifts
- Parallel Synchronous Loading
- Direct Overriding Clear
- Temporary Data-Latching Capability
- Package Options Include Plastic Small-Outline Packages (D), Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

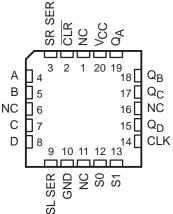
#### description

These 4-bit bidirectional universal shift registers feature parallel outputs, right-shift and left-shift serial (SR SER, SL SER) inputs, operatingmode-control (S0, S1) inputs, and a direct overriding clear (CLR) line. The registers have four distinct modes of operation:

- Inhibit clock (temporary data latch/do nothing)
- Shift right (in the direction Q<sub>A</sub> toward Q<sub>D</sub>)
- Shift left (in the direction Q<sub>D</sub> toward Q<sub>A</sub>)
- Parallel (broadside) load

Parallel synchronous loading is accomplished by applying the four bits of data and taking both S0 and S1 high. The data is loaded into the associated flip-flops and appears at the outputs after the positive transition of the clock (CLK) input. During loading, serial data flow is inhibited.





NC - No internal connection

Shift right is accomplished synchronously with the rising edge of the clock pulse when S0 is high and S1 is low. Serial data for this mode is entered at the shift-right data input. When S0 is low and S1 is high, data shifts left synchronously and new data is entered at the shift-left serial inputs. Clocking of the flip-flop is inhibited when both mode-control inputs are low.

The SN54AS194 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74AS194 is characterized for operation from 0°C to 70°C.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



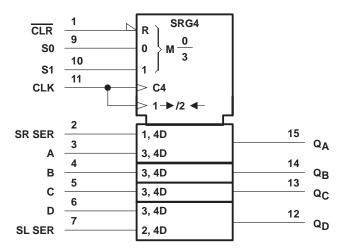
POST OFFICE BOX 655303 
DALLAS, TEXAS 75265
POST OFFICE BOX 1443 
HOUSTON TEXAS 77251-1443

SDAS212A - DECEMBER 1983 - REVISED DECEMBER 1994

_					F	UNCTIC	N TABL	E		_			
				INP	UTS						OUTI	PUTS	
	MO	DE		SEI	RIAL		PARA	LLEL			0	0.	0
CLR	<b>S</b> 1	S0	CLK	LEFT	RIGHT	Α	В	С	D	QA	QB	QC	QD
L	Х	Х	Х	Х	Х	Х	Х	Х	Х	L	L	L	L
н	Х	Х	L	Х	Х	Х	Х	Х	Х	Q <sub>A0</sub>	$Q_{B0}$	Q <sub>C0</sub>	$Q_{D0}$
н	Н	Н	Ŷ	Х	Х	а	b	С	d	а	b	С	d
н	L	Н	Ŷ	Х	Н	Х	Х	Х	Х	н	Q <sub>An</sub>	Q <sub>Bn</sub>	Q <sub>Cn</sub>
н	L	Н	Ŷ	Х	L	Х	Х	Х	Х	L	Q <sub>An</sub>	Q <sub>Bn</sub>	Q <sub>Cn</sub>
н	Н	L	Ŷ	Н	Х	Х	Х	Х	Х	Q <sub>Bn</sub>	Q <sub>Cn</sub>	Q <sub>Dn</sub>	Н
н	Н	L	Ŷ	L	Х	Х	Х	Х	Х	Q <sub>Bn</sub>	Q <sub>Cn</sub>	Q <sub>Dn</sub>	L
Н	L	L	Х	Х	Х	Х	Х	Х	Х	Q <sub>A0</sub>	Q <sub>B0</sub>	Q <sub>C0</sub>	Q <sub>D0</sub>

H = high level (steady state); L = low level (steady state); X = irrelevant (any input, including transitions);  $\uparrow$  = transition from low to high level; a, b, c, d = the level of steady-state input at inputs A, B, C, or D, respectively; QA0, QB0, QC0, QD0 = the level of QA, QB, QC, or QD, respectively, before the indicated steady-state input conditions were established; QAn, QBn, QCn, QDn = the level of QA, QB, QC, or QD, respectively, before the most recent  $\uparrow$  transition of the clock.

#### logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



SDAS212A - DECEMBER 1983 - REVISED DECEMBER 1994

1**S** 

1R

R

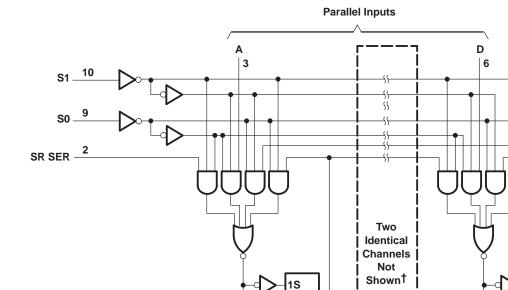
Parallel Outputs

> C1

12

 $Q_D$ 

7 SL SER



> C1

15

1R

R

logic diagram (positive logic)

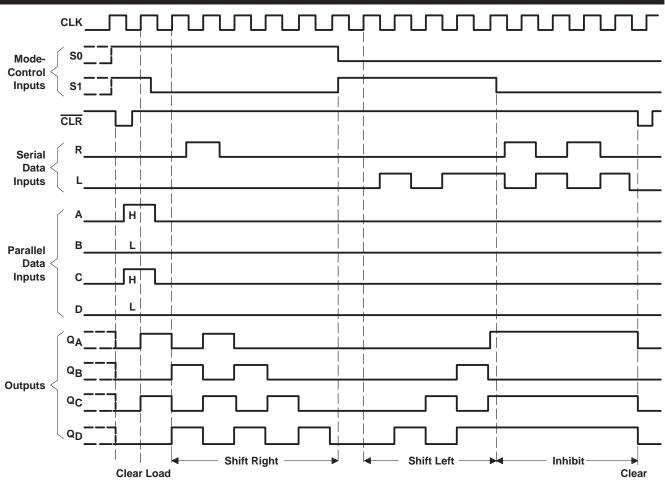
 $$\mathbf{Q}_{\mathbf{A}}$$   $$\mathbf{V}_{\mathbf{C}}$$  1/O ports not shown:  $\mathsf{Q}_{\mathbf{B}}$  (14) and  $\mathsf{Q}_{\mathbf{C}}$  (13)

Pin numbers shown are for the D, J, and N packages.

CLK \_\_\_\_\_

 $\overline{\text{CLR}}$  -1





SDAS212A - DECEMBER 1983 - REVISED DECEMBER 1994

Figure 1. Typical Clear, Load, Right-Shift, and Clear Sequences

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, V <sub>CC</sub>	
Input voltage, V <sub>I</sub>	
Operating free-air temperature range, T <sub>A</sub> : SN54AS194	–55°C to 125°C
SN74AS194	
Storage temperature range	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



SDAS212A - DECEMBER 1983 - REVISED DECEMBER 1994

### recommended operating conditions

			SI	N54AS19	94	SN	N74AS19	4	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.8			0.8	V
ЮН	High-level output current				-2			-2	mA
IOL	Low-level output current				20			20	mA
fclock*	Clock frequency		0		75	0		80	MHz
		CLR	4			4.5			
tw*	Pulse duration	CLK high	4			4			ns
		CLK low	6			7			
		Select	9			9.5			
<sup>t</sup> su <sup>*</sup>	Setup time before CLK <sup>↑</sup>	Data	3.5			4			ns
		Clear inactive state	6			6			
t <sub>h</sub> *	Hold time, data after $CLK^\uparrow$		0.5			0.5			ns
TA	Operating free-air temperature		-55		125	0		70	°C

\* On products compliant to MIL-STD-883, Class B, these parameters are based on characterization data, but are not production tested.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		7507.001		SN	154AS19	94	SN				
	PARAMETER	TEST CON	TEST CONDITIONS			MAX	MIN	TYP†	MAX	UNIT	
VIK		V <sub>CC</sub> = 4.5 V,	lı = – 18 mA			-1.2			-1.2	V	
VOH		V <sub>CC</sub> = 4.5 V to 5.5 V,	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2			V <sub>CC</sub> -2			V	
VOL		V <sub>CC</sub> = 4.5 V,	I <sub>OL</sub> = 20 mA		0.35	0.5		0.35	0.5	V	
	Data, CLK, CLR		\/ <b>7</b> \/			0.1			0.1		
1	Mode, SL, SR	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 7 V			0.2			0.2	mA	
	Data, CLK, CLR					20			20		
ЧΗ	Mode, SL, SR	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			40			40	μA	
	Data, CLK, CLR					-0.5			-0.5		
ΊL	Mode, SL, SR	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V		-1				-1	-1 mA	
10‡		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-30		-112	-30		-112	mA	
			Outputs high		30	49		30	43	mA	
ICC		V <sub>CC</sub> = 5.5 V	Outputs low		38	60		38	53		

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.
 <sup>‡</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I<sub>OS</sub>.



SDAS212A - DECEMBER 1983 - REVISED DECEMBER 1994

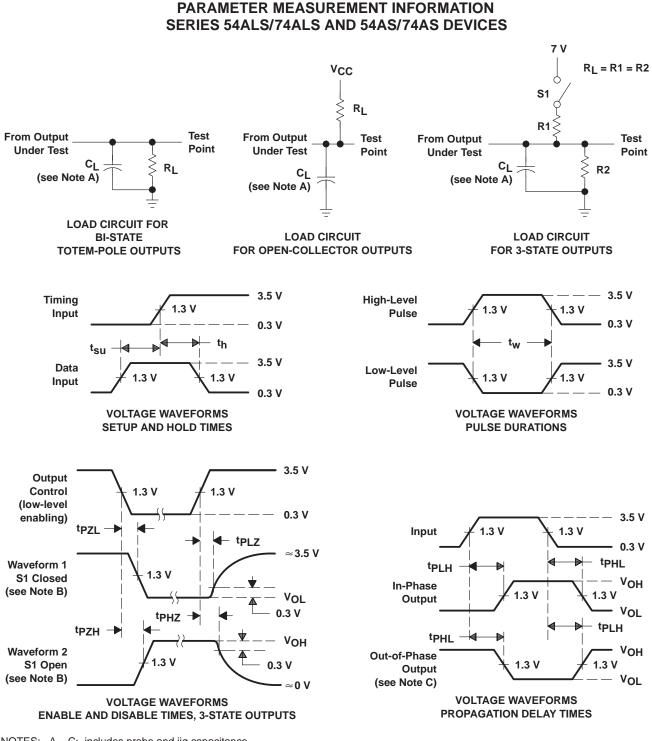
#### switching characteristics (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL RL	$\label{eq:CC} \begin{array}{l} V_{CC} = 4.5 \ V \ to \ 5.5 \ V, \\ C_L = 50 \ pF, \\ R_L = 500 \ \Omega, \\ T_A = MIN \ to \ MAX^{\dagger} \\ \hline \\ SN54AS194 \qquad SN74AS194 \end{array}$			
			SN54AS194 SN74AS194 MIN MAX MIN MAX				
					MIN	MAX	
<sup>f</sup> max*			75		80		MHz
<sup>t</sup> PLH	OLK	Amu 0	2.5	8	3	7	
<sup>t</sup> PHL	CLK	Any Q	2.5	8	3	7	ns
<sup>t</sup> PHL	CLR	Any Q	3.5	13	4	12	ns

\* On products compliant to MIL-STD-883, Class B, these parameters are based on characterization data, but are not production tested. † For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



SDAS212A - DECEMBER 1983 - REVISED DECEMBER 1994



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz, t<sub>f</sub> = t<sub>f</sub> = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.
  - . The outputs are measured one at a time with one transition per measurement.

#### Figure 2. Load Circuits and Voltage Waveforms





#### **PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN74AS194D	Obsolete	Production	SOIC (D)   16	-	-	Call TI	Call TI	0 to 70	AS194
SN74AS194DR	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS194
SN74AS194DR.A	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS194

<sup>(1)</sup> **Status:** For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



www.ti.com

### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AS194DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1



www.ti.com

# PACKAGE MATERIALS INFORMATION

16-Apr-2024



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AS194DR	SOIC	D	16	2500	340.5	336.1	32.0

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



### **IMPORTANT NOTICE AND DISCLAIMER**

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2025, Texas Instruments Incorporated